

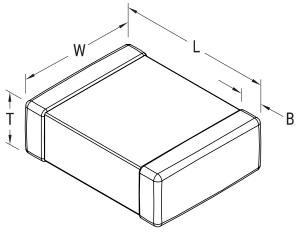
CBR08C499CAGAC

General Information

Series

Style

CBR-SMD RF COG, Ceramic, 4.9 pF, +/-0.25 pF, 250 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0805



Specifications Capacitance

Quality Factor

Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	12.03 mg
Notes	Solder Wave or Solder Reflow.
Shelf Life	78 Weeks
MSL	1

4.9 pF

498

CBR-SMD RF COG

SMD Chip

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
т	0.85mm +/-0.1mm
В	0.5mm +/-0.2mm

Click here for the 3D model.

	Tolerance	+/-0.25 pF
	Voltage DC	250 VDC
	Dielectric Withstanding Voltage	500 VDC
	Temperature Range	-55/+125°C
	Temp. Coefficient	COG
	Dissipation Factor	0.201%
be	Aging Rate	0% Loss/Decade Hour
	Insulation Resistance	10 GOhms

Packaging Specifications

Packaging Packaging Quantity T&R, 180mm, Plastic Tap 4000

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